

### STL150N3LLH5

N-channel 30 V, 0.0014 Ω 35 A - PowerFLAT™ (6x5) STripFET™ V Power MOSFET

#### **Features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STL150N3LLH5	30 V	<0.00175 Ω	35 A <sup>(1)</sup>

- 1. The value is rated according  $R_{thj\text{-pcb}}$
- R<sub>DS(on)</sub> \* Q<sub>g</sub> industry benchmark
- Extremely low on-resistance R<sub>DS(on)</sub>
- High avalanche ruggedness
- Low gate drive power losses

#### **Application**

Switching applications

#### **Description**

This product utilizes the 5<sup>th</sup> generation of design rules of ST's proprietary STripFET<sup>TM</sup> technology. The lowest available  $R_{DS(on)}^*Q_g$ , in this chip scale package, makes this device suitable for the most demanding DC-DC converter applications, where high power density is to be achieved.

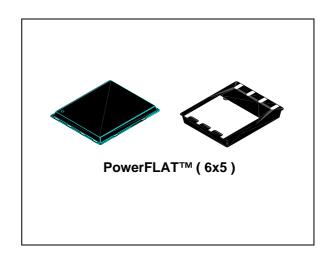


Figure 1. Internal schematic diagram

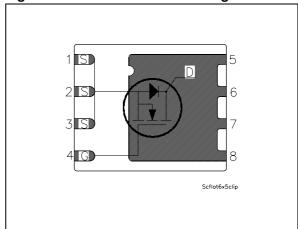


Table 1. Device summary

Order code Marking		Package	Packaging	
STL150N3LLH5	150N3LLH5	PowerFLAT™ (6x5)	Tape and reel	

Contents STL150N3LLH5

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STL150N3LLH5 Electrical ratings

## 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	30	V
V <sub>GS</sub>	Gate-source voltage	± 22	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	150	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	94	Α
I <sub>D</sub> <sup>(2)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	35	Α
I <sub>D</sub> <sup>(3)</sup>	Drain current (continuous) at T <sub>C</sub> =100 °C	21.8	Α
I <sub>DM</sub> <sup>(3)</sup>	Drain current (pulsed)	140	Α
P <sub>TOT</sub> <sup>(1)</sup>	Total dissipation at T <sub>C</sub> = 25 °C	80	W
P <sub>TOT</sub> (3)	Total dissipation at T <sub>C</sub> = 25 °C	4	W
	Derating factor	0.03	W/°C
T <sub>J</sub> T <sub>stg</sub>	Operating junction temperature Storage temperature	-55 to 150	°C

<sup>1.</sup> The value is rated according  $R_{\text{thj-c}}$ 

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case (drain) (steady state)	1.56	°C/W
R <sub>thj-pcb</sub> (1)	Thermal resistance junction-ambient	31.3	°C/W

<sup>1.</sup> When mounted on FR-4 board of 1inch², 2oz Cu, t < 10 sec

Table 4. Avalanche data

Symbol	Parameter	Value	Unit
I <sub>AV</sub>	Not-repetitive avalanche current, (pulse width limited by Tj Max)	17	Α
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AV}$ , $V_{DD} = 24$ V)	300	mJ

<sup>2.</sup> The value is rated according  $R_{\mbox{\scriptsize thj-pcb}}$ 

<sup>3.</sup> Pulse width limited by safe operating area

Electrical characteristics STL150N3LLH5

## 2 Electrical characteristics

 $(T_{CASE} = 25 \, ^{\circ}C \text{ unless otherwise specified})$ 

Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	30			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating, $V_{DS}$ = Max rating @125 °C			1 10	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ±22 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			٧
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS}$ = 10 V, $I_{D}$ = 17.5 A $V_{GS}$ = 4.5 V, $I_{D}$ = 17.5 A		0.0014 0.0019	0.00175 0.0024	$\Omega$

Table 6. Dynamic

Symbol	Parameter	Test conditions		Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> = 25 V, f=1 MHz, V <sub>GS</sub> =0		5800 1147 127		pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD}$ =15 V, $I_D$ = 35 A $V_{GS}$ =4.5 V (see Figure 14)		40 13.4 14.9		nC nC nC
R <sub>G</sub>	Gate input resistance	f=1 MHz Gate DC Bias = 0 Test signal level = 20 mV open drain		1.1		Ω

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$t_{d(on)}$ $t_{r}$ $t_{d(off)}$ $t_{f}$	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD}$ =15 V, $I_{D}$ = 17.5 A, $R_{G}$ =4.7 $\Omega$ $V_{GS}$ =10 V (see Figure 13)		17.2 30.8 65.8 47.8		ns ns ns ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current				35	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)				140	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 35 A, V <sub>GS</sub> =0			1.1	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 35 \text{ A},$ $di/dt = 100 \text{ A/}\mu\text{s},$ $V_{DD} = 25 \text{ V}$		43.8 46 2.1		ns nC A

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: pulse duration=300µs, duty cycle 1.5%

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#### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

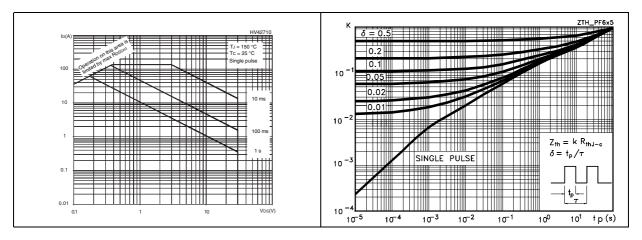


Figure 4. Output characteristics

Figure 5. Transfer characteristics

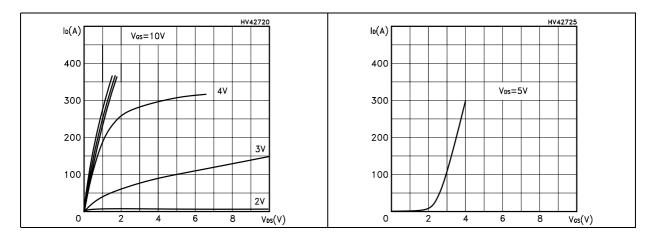
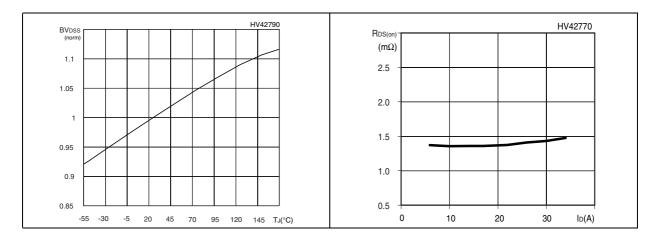


Figure 6. Normalized B<sub>VDSS</sub> vs temperature

Figure 7. Static drain-source on resistance



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Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

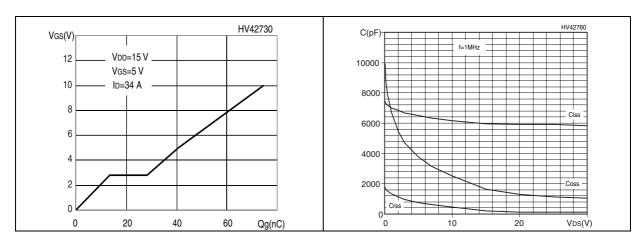


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

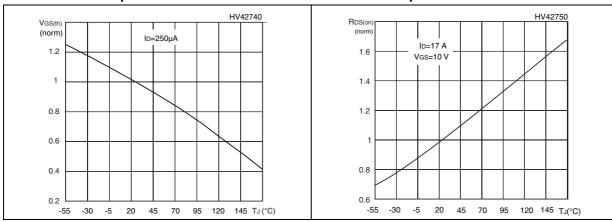
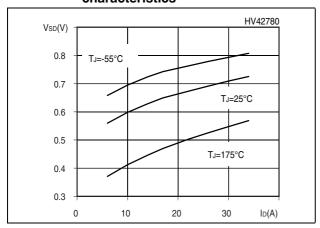


Figure 12. Source-drain diode forward characteristics



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Test circuits STL150N3LLH5

#### 3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

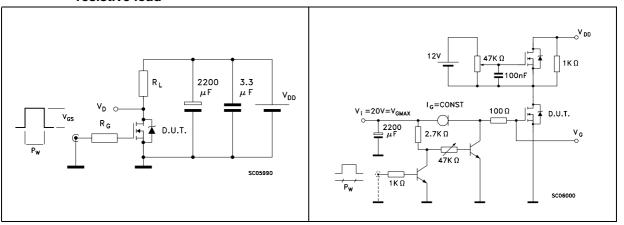


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

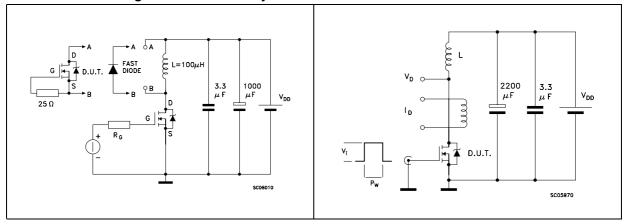
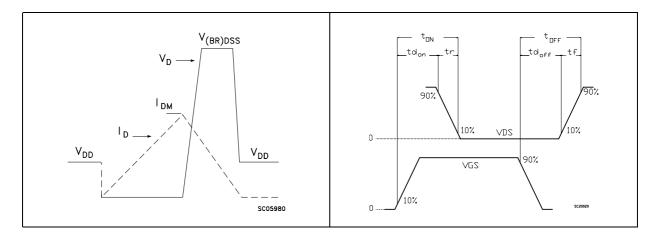


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



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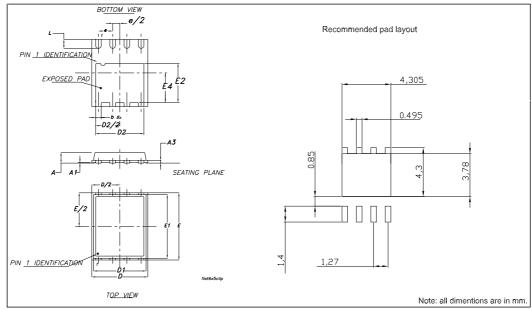
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

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PowerFLAT™	(6x5)	m echar	nicaldata
T OW CTT TIVE	$(0\Delta)$	m Ecriai	I I CAT CACA

DM.		mm.			inch	
DM.	Min.	Тур.	Max.	Min.	Тур.	Max.
А	08.0	0.83	0.93	0.031	0.32	0.036
A1		0.02	0.05		0.0007	0.0019
A3		0.20			0.007	
b	0.35	0.40	0.47	0.013	0.015	0.018
D		5.00			0.196	
D1		4.75			0.187	
D2	4.15	4.20	4.25	0.163	0.165	0.167
E		6.00			0 236	
E1		5.75			0 226	
E2	3.43	3.48	3.53	0.135	0.137	0.139
E4	2.58	2.63	2.68		0.103	0.105
е		1.27			0.050	
L	0.70	08.0	0.90	0.027	0.031	0.035



STL150N3LLH5 Revision history

# 5 Revision history

Table 9. Document revision history

Date	Revision	Changes
22-Oct-2007	1	First release
01-Apr-2008	2	Document status promoted from preliminary data to datasheet
23-Sep-2008	3	V <sub>GS</sub> value has been changed on <i>Table 2</i> and <i>Table 5</i>

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